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PATENT
5298-03500/PM99021

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of:
Lau

Serial No. 09/476,669

Filed: December 30, 1999

For: METHOD FOR FORMING A METALLIZATION STRUCTURE IN AN INTEGRATED CIRCUIT

Group Art Unit: 1745
Examiner: G. Cantelmo

Atty. Docket No. 5298-03500

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on the date indicated below:

December 2, 2002
Date

Kevin L. Daffer

NOTICE OF APPEAL

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Commissioner of Patents & Trademarks
Washington D.C. 20231

Sir:

Applicants hereby appeal to the Board of Patent Appeals and Interferences from the final Office Action dated August 30, 2002 rejecting claims 1-11 and 30.

The Commissioner is authorized to charge the required fee of $320.00, or credit any overpayment to Conley, Rose & Tayon, P.C. Deposit Account No. 50-1505/5298-03500.

Respectfully submitted,

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